Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>CAVC2T45TDCURQ1</u>

For any questions, you can email us directly: sales@integrated-circuit.com

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN74AVC2T45-Q1

www.ti.com SCES813 – JUNE 2010

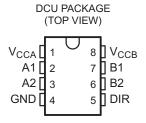
DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

Check for Samples: SN74AVC2T45-Q1

FEATURES

- Qualified for Automotive Applications
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- I_{off} Supports Partial-Power-Down Mode Operation
- Max Data Rates
 - 500 Mbps (1.8-V to 3.3-V Translation)
 - 320 Mbps (<1.8-V to 3.3-V Translation)
 - 320 Mbps (Translate to 2.5 V or 1.8 V)
 - 280 Mbps (Translate to 1.5 V)
 - 240 Mbps (Translate to 1.2 V)

- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



DESCRIPTION

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

The SN74AVC2T45 is designed so that the DIR input is powered by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

ORDERING INFORMATION(1)

T _A	PACK	AGE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 105°C	VSSOP - DCU	Reel of 3000	CAVC2T45TDCURQ1	SBUI

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74AVC2T45-Q1



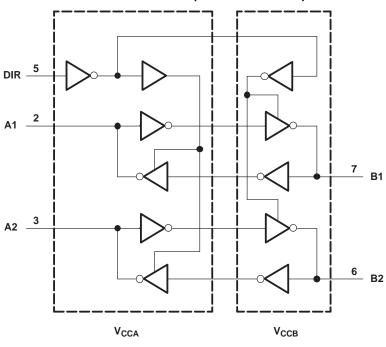
SCES813 – JUNE 2010 www.ti.com

FUNCTION TABLE⁽¹⁾ (EACH TRANSCEIVER)

INPUT DIR	OPERATION
L	B data to A bus
Н	A data to B bus

(1) Input circuits of the data I/Os always are active.

LOGIC DIAGRAM (POSITIVE LOGIC)



Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8





SN74AVC2T45-Q1

www.ti.com SCES813 – JUNE 2010

ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CCA}	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
V_{I}	Input voltage range (2)	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output in the high-impedance or power-off state (2)	A port	-0.5	4.6	V
Vo	power-off state ⁽²⁾	B port	-0.5	4.6	V
V	Valtage range applied to any output in the high or law state (2) (3)	A port	-0.5	V _{CCA} + 0.5	V
Vo	Voltage range applied to any output in the high or low state (2) (3)	B port	-0.5	V _{CCB} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		-50	mA
lok	Output clamp current	V _O < 0		-50	mA
Io	Continuous output current	•		±50	mA
	Continuous current through V _{CCA} , V _{CCB} , or GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾	DCU package		227	°C/W
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current ratings are observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74AVC2T45-Q1



SCES813 - JUNE 2010 www.ti.com

RECOMMENDED OPERATING CONDITIONS (1)(2)(3)(4)(5)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V_{CCA}	Supply voltage				1.2	3.6	V
V_{CCB}	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		$V_{\rm CCI} \times 0.65$		
V_{IH}	High-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCI} \times 0.35$	
V_{IL}	Low-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V			0.7	V
	mpat voltago		2.7 V to 3.6 V			0.8	
			1.2 V to 1.95 V		$V_{CCA} \times 0.65$		
V_{IH}	High-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V		1.6		V
	mpat voltago	(Totoronood to VCCA)	2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCA} \times 0.35$	
V_{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V			0.7	V
	input voltage	(referenced to V _{CCA})	2.7 V to 3.6 V			0.8	
V_{I}	Input voltage				0	3.6	V
Vo	Output voltage	Active state			0	V_{CCO}	V
٧٥	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
I _{OH}	High-level output	current		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
I _{OL}	Low-level output of	current		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δν	Input transition ris	e or fall rate				5	ns/V
T _A	Operating free-air	temperature			-40	105	°C

 V_{CCI} is the V_{CC} associated with the input port. V_{CCO} is the V_{CC} associated with the output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. See the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V. For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8





SN74AVC2T45-Q1

SCES813 - JUNE 2010

ELECTRICAL CHARACTERISTICS(1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

	METER	TEST COND	ITIONS	V	V		$T_A = 25$ °C		-40°C to 10	5°C	UNIT
PAKA	WEIER	TEST COND	IIIONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	MIN	MAX	UNIT
		$I_{OH} = -100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V				V _{CCO} - 0.2 V		
		$I_{OH} = -3 \text{ mA}$		1.2 V	1.2 V		0.95				
. ,		$I_{OH} = -6 \text{ mA}$., ,,	1.4 V	1.4 V				1.05		\ /
V _{OH}		$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V				1.2		V
		$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
	I _{OH} = −12 mA			3 V	3 V				2.3		
	I _{OL} = 100 μA			1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
$I_{OL} = 3 \text{ mA}$		$I_{OL} = 3 \text{ mA}$		1.2 V	1.2 V		0.25				
,		I _{OL} = 6 mA	., ,,	1.4 V	1.4 V					0.35	V
V _{OL}		$I_{OL} = 8 \text{ mA}$	$V_I = V_{IL}$	1.65 V	1.65 V					0.45	٧
		$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V					0.55	
		I _{OL} = 12 mA		3 V	3 V					0.7	
I	DIR	V _I = V _{CCA} or GN	ID .	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μА
	A port	\/ or \/ O to 3			0 to 3.6 V		±0.1	±1		±5	^
off	B port	V_I or $V_O = 0$ to 3	3.6 V	0 to 3.6 V	0 V		±0.1	±1		±5	μА
	B port	$V_O = V_{CCO}$ or G	ND,	0 V	3.6 V		±0.5	±2.5		±5	
oz	A port	$V_I = V_{CCI}$ or GN	D	3.6 V	0 V		±0.5	±2.5		±5	μΑ
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
CCA		$V_I = V_{CCI}$ or GN	D, $I_0 = 0$	0 V	3.6 V					-2	μΑ
				3.6 V	0 V					10	
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
ССВ		$V_I = V_{CCI}$ or GN	D, $I_0 = 0$	0 V	3.6 V					10	μΑ
				3.6 V	0 V					-2	
CCA +	I _{CCB} able 1)	V _I = V _{CCI} or GN	D, I _O = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					20	μΑ
	Control inputs	V _I = 3.3 V or GN	ND	3.3 V	3.3 V		2.5				pF
	A or B	V _O = 3.3 V or G	ND	3.3 V	3.3 V		6				pF

⁽¹⁾ V_{CCO} is the V_{CC} associated with the output port.

⁽²⁾ V_{CCI} is the V_{CC} associated with the input port.

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74AVC2T45-Q1



SCES813 – JUNE 2010 www.ti.com

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 1)

DADAMETED	FROM	то	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3.3 V	LINUT
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	UNIT
t _{PLH}	Α	В	3.1	2.6	2.4	2.2	2.2	
t _{PHL}	A	Б	3.1	2.6	2.4	2.2	2.2	ns
t _{PLH}	В	Α	3.4	3.1	3	2.9	2.9	20
t _{PHL}	ь	A	3.4	3.1	3	2.9	2.9	ns
t _{PHZ}	DIR	Α	5.2	5.2	5.1	5	4.8	
t _{PLZ}	DIK	A	5.2	5.2	5.1	5	4.8	ns
t _{PHZ}	DID	В	5	4	3.8	2.8	3.2	
t _{PLZ}	DIR	В	5	4	3.8	2.8	3.2	ns
t _{PZH} (1)	DID	^	8.4	7.1	6.8	5.7	6.1	
t _{PZL} ⁽¹⁾	DIR	Α	8.4	7.1	6.8	5.7	6.1	ns
t _{PZH} (1)	DID	DIR B	8.3	7.8	7.5	7.2	7	
t _{PZL} ⁽¹⁾	DIK		8.3	7.8	7.5	7.2	7	ns

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1			V _{CCB} = 1.8 V ± 0.15 V		2.5 V 2 V	V _{CCB} = 3.3 V ± 0.3 V		UNIT		
	(INPUT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX			
t _{PLH}	А	В	2.8	0.7	5.6	0.5	4.8	0.4	3.9	0.3	3.7			
t _{PHL}	A	В	2.8	0.7	5.6	0.5	4.8	0.4	3.9	0.3	3.7	ns		
t _{PLH}	В	Α	2.7	0.8	5.6	0.7	5.4	0.6	5.1	0.5	4.9	20		
t _{PHL}	ь	A	2.7	0.8	5.6	0.7	5.4	0.6	5.1	0.5	4.9	ns		
t _{PHZ}	DIR	Α	3.9	1.3	8.7	1.3	8	1.1	7.9	1.4	7.8	20		
t _{PLZ}	DIK	A	3.9	1.3	8.7	1.3	8	1.1	7.9	1.4	7.8	ns		
t _{PHZ}	DIR	В	4.7	1.1	7.2	1.4	7.1	1.2	7.1	1.7	7.3	20		
t _{PLZ}	DIK	Ь	4.7	1.1	7.2	1.4	7.1	1.2	7.1	1.7	7.3	ns		
t _{PZH} (1)	DIR	^	7.4		12.6		12.3		12		12	20		
t _{PZL} (1)	DIK	Α	7.4		12.6		12.3		12		12	ns		
t _{PZH} (1)	DID	В	6.7		14.1		12.6		11.6		11.3	20		
t _{PZL} ⁽¹⁾	DIR	DIR	DIR	В	6.7		14.1		12.6		11.6		11.3	ns

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN74AVC2T45-Q1

SCES813 - JUNE 2010

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.7		V _{CCB} = 1.8 V ± 0.15 V		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT							
	(INPUT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX								
t _{PLH}	А	В	2.7	0.5	5.4	0.4	4.5	0.2	3.6	0.2	3.3								
t _{PHL}	A	В	2.7	0.5	5.4	0.4	4.5	0.2	3.6	0.2	3.3	ns							
t _{PLH}	В	^	2.4	0.7	4.9	0.5	4.6	0.5	4.2	0.4	4								
t _{PHL}	В	Α	2.4	0.7	4.9	0.5	4.6	0.5	4.2	0.4	4	ns							
t _{PHZ}	DIR	Α	3.7	1.3	8.3	0.7	7.1	1.4	5.5	1.1	5.4								
t_{PLZ}	DIK	A	3.7	1.3	8.3	0.7	7.1	1.4	5.5	1.1	5.4	ns							
t _{PHZ}	DIR	В	4.4	1.3	6	1.3	6.1	0.8	5.9	1.5	6.1								
t_{PLZ}	DIK	В	4.4	1.3	6	1.3	6.1	0.8	5.9	1.5	6.1	ns							
t _{PZH} ⁽¹⁾	DIR	Α	6.8		10.7		10.5		9.9		9.9								
t _{PZL} ⁽¹⁾	DIK	A	6.8		10.7		10.5		9.9		9.9	ns							
t _{PZH} ⁽¹⁾	DID	Б	6.4		13.5		11.4		8.9		8.5								
t _{PZL} ⁽¹⁾	DIR	В	В	В	В	В	В	В	В	6.4		13.5		11.4		8.9		8.5	ns

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V ± 0.1 V		V _{CCB} = ± 0.1		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT				
	(INPUT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX					
t _{PLH}	Α	В	2.6	0.4	5.1	0.2	4.2	0.2	3.2	0.2	2.8	no				
t _{PHL}	A	Ь	2.6	0.4	5.1	0.2	4.2	0.2	3.2	0.2	2.8	ns				
t _{PLH}	В	Α	2.1	0.6	4	0.5	3.6	0.4	3.2	0.3	3	20				
t _{PHL}	ь	A	2.1	0.6	4	0.5	3.6	0.4	3.2	0.3	3	ns				
t _{PHZ}	DIR	Α	2.4	0.7	8.1	0.8	6.6	0.8	5.2	0.5	4.5	no				
t _{PLZ}	DIK	A	2.4	0.7	8.1	0.8	6.6	0.8	5.2	0.5	4.5	ns				
t _{PHZ}	DIR	В	3.8	1	4.5	0.6	4.5	0.5	4.4	1.1	4.3	20				
t _{PLZ}	DIK	Ь	3.8	1	4.5	0.6	4.5	0.5	4.4	1.1	4.3	ns				
t _{PZH} ⁽¹⁾	DIR	^	5.9		8.7		7.9		7.4		7.1	20				
t _{PZL} (1)	אוט	Α	5.9		8.7		7.9		7.4		7.1	ns				
t _{PZH} (1)	DID	В	5		13		10.6		8.2		7.1					
t _{PZL} ⁽¹⁾	DIR	DIR	DIR	DIR	DIR	В	5		13		10.6		8.2		7.1	ns

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN74AVC2T45-Q1



SCES813 – JUNE 2010 www.ti.com

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1	1.5 V I V	V _{CCB} = ± 0.1	1.8 V 5 V	V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT																					
	(INFOT)	(0011-01)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																						
t _{PLH}	Α	В	2.5	0.3	4.9	0.2	4	0.2	3	0.2	2.6																						
t _{PHL}	А	В	2.5	0.3	4.9	0.2	4	0.2	3	0.2	2.6	ns																					
t _{PLH}	В	^	2.1	0.6	3.8	0.4	3.3	0.3	2.8	0.3	2.6																						
t _{PHL}	В	Α	2.1	0.6	3.8	0.4	3.3	0.3	2.8	0.3	2.6	ns																					
t _{PHZ}	DIR	Α	2.9	1.1	8.2	1	6.7	1.3	4.9	1.2	4.2	20																					
t_{PLZ}	DIK	A	2.9	1.1	8.2	1	6.7	1.3	4.9	1.2	4.2	ns																					
t _{PHZ}	DIR	В	3.4	0.5	6.8	0.3	5.8	0.3	4.8	1.1	4.4																						
t_{PLZ}	DIK	В	3.4	0.5	6.8	0.3	5.8	0.3	4.8	1.1	4.4	ns																					
t _{PZH} (1)	DIR	Α	5.5		10.4		8.9		7.4		6.8																						
t _{PZL} ⁽¹⁾	אוט	A	5.5		10.4		8.9		7.4		6.8	ns																					
t _{PZH} (1)	DID	В	5.4		12.9		10.5		7.7		6.6																						
t _{PZL} (1)	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	В	5.4		12.9		10.5		7.7		6.6	ns

⁽¹⁾ The enable time is a calculated value, derived using the formula shown in the enable times section.

OPERATING CHARACTERISTICS

 $T_{\Lambda} = 25^{\circ}C$

P	ARAMETER	TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.2 V	V _{CCA} = V _{CCB} = 1.5 V	V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	UNIT
C (1)	A-port input, B-port output	$C_L = 0$, f = 10 MHz,	3	3	3	3	4	~F
C _{pdA} (1)	B-port input, A-port output	$t_r = t_f = 1 \text{ ns}$	12	13	13	14	15	pF
o (1)	A-port input, B-port output	$C_L = 0$,	12	13	13	14	15	Ļ
C _{pdB} ⁽¹⁾	B-port input, A-port output	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	3	3	3	3	4	pF

(1) Power-dissipation capacitance per transceiver

Submit Documentation Feedback

Copyright © 2010, Texas Instruments Incorporated

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



SN74AVC2T45-Q1

www.ti.com SCES813 – JUNE 2010

Power-Up Considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up V_{CCA}.
- 3. V_{CCB} can be ramped up along with or after V_{CCA} .

Table 1. Typical Total Static Power Consumption ($I_{CCA} + I_{CCB}$)

V		V _{CCA}									
V _{CCB}	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	UNIT				
0 V	0	<0.5	<0.5	<0.5	<0.5	<0.5					
1.2 V	<0.5	<1	<1	<1	<1	1					
1.5 V	<0.5	<1	<1	<1	<1	1					
1.8 V	<0.5	<1	<1	<1	<1	<1	μΑ				
2.5 V	<0.5	1	<1	<1	<1	<1					
3.3 V	<0.5	1	<1	<1	<1	<1					

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

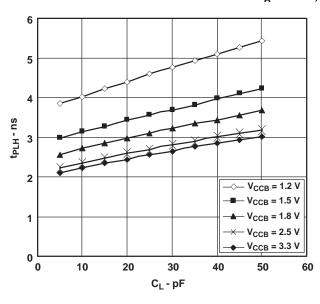
SN74AVC2T45-Q1

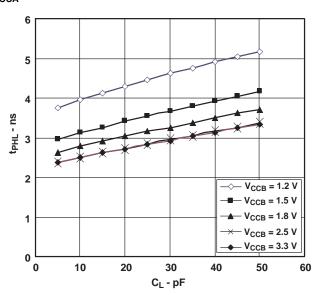


SCES813 – JUNE 2010 www.ti.com

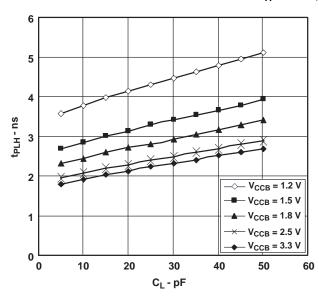
TYPICAL CHARACTERISTICS

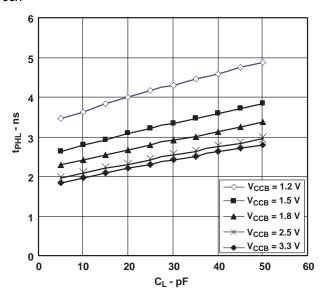
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}\text{C}$, $V_{CCA} = 1.2 \text{ V}$





TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 1.5$ V





Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

www.ti.com

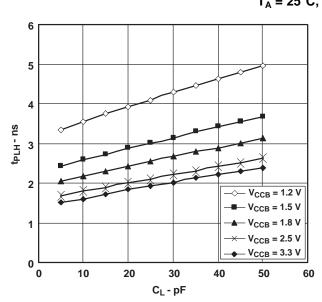


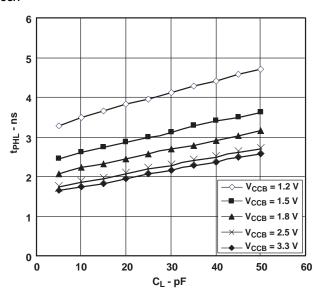
SN74AVC2T45-Q1

SCES813 - JUNE 2010

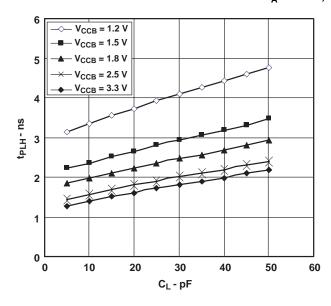
TYPICAL CHARACTERISTICS (continued)

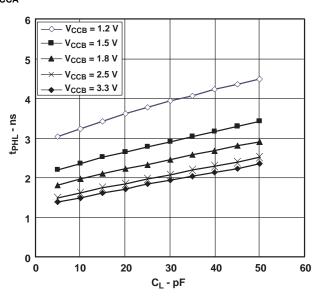
TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C, V_{CCA} = 1.8 \text{ V}$





TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25$ °C, $V_{CCA} = 2.5 V$





Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

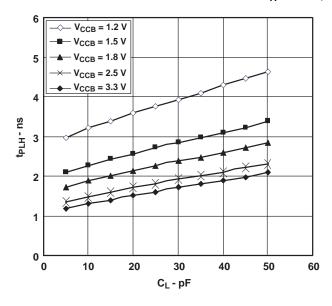
SN74AVC2T45-Q1

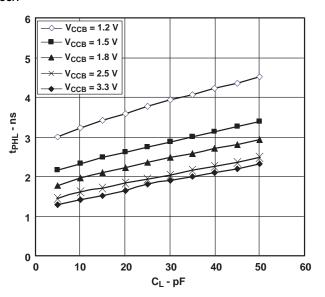


SCES813 – JUNE 2010 www.ti.com

TYPICAL CHARACTERISTICS (continued)

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}\text{C}$, $V_{\text{CCA}} = 3.3 \text{ V}$





Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

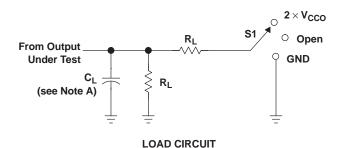


SN74AVC2T45-Q1

V_{CCA}

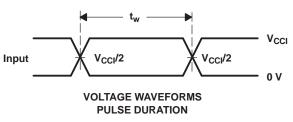
www.ti.com SCES813 – JUNE 2010

PARAMETER MEASUREMENT INFORMATION



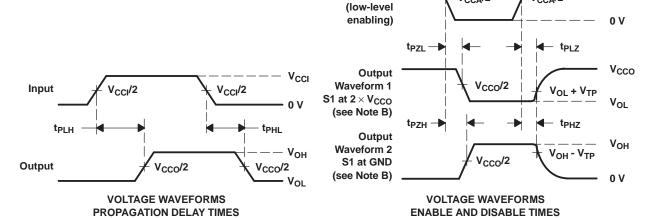
TEST	S1			
t _{pd}	Open			
t _{PLZ} /t _{PZL}	2×V _{CCO}			
t _{PHZ} /t _{PZH}	GND			





V_{CCA}/2

V_{CCA}/2



Output Control

- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $dv/dt \geq$ 1 V/ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

Figure 1. Load Circuit and Voltage Waveforms

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

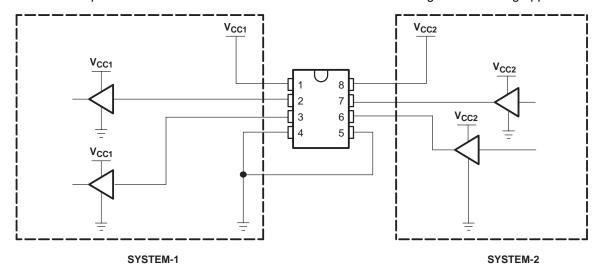
SN74AVC2T45-Q1



SCES813 – JUNE 2010 www.ti.com

APPLICATION INFORMATION

Figure 2 is an example circuit of the SN74AVC2T45 used in a unidirectional logic level-shifting application.



PIN	NAME	FUNCTION	DESCRIPTION				
1	V_{CCA}	V _{CC1}	SYSTEM-1 supply voltage (1.2 V to 3.6 V)				
2	A1	OUT1	Output level depends on V _{CC1} voltage.				
3	A2	OUT2	Output level depends on V _{CC1} voltage.				
4	GND	GND	Device GND				
5	DIR	DIR	The GND (low-level) determines B-port to A-port direction.				
6	B2	IN2	Input threshold value depends on V _{CC2} voltage.				
7	B1	IN1	Input threshold value depends on V _{CC2} voltage.				
8	V _{CCB}	V _{CC2}	SYSTEM-2 supply voltage (1.2 V to 3.6 V)				

Figure 2. Unidirectional Logic Level-Shifting Application

Submit Documentation Feedback

Copyright © 2010, Texas Instruments Incorporated

www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

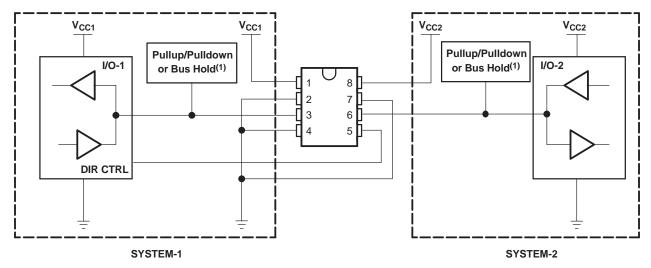


SN74AVC2T45-Q1

SCES813 - JUNE 2010

APPLICATION INFORMATION

Figure 3 shows the SN74AVC2T45 used in a bidirectional logic level-shifting application. Since the SN74AVC2T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.



Following is a sequence that illustrates data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-1.

STATE	DIR CTRL	I/O-1	I/O-2	DESCRIPTION
1	Н	Out	In	SYSTEM-1 data to SYSTEM-2
2	Н	Hi-Z	Hi-Z	SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. (1)
3	L	Hi-Z	Hi-Z	DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. ⁽¹⁾
4	L	In	Out	SYSTEM-2 data to SYSTEM-1

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

Figure 3. Bidirectional Logic Level-Shifting Application

Enable Times

Calculate the enable times for the SN74AVC2T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZI} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHI} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.



Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

17-Aug-2015

PACKAGING INFORMATION

Lead/Ball Finish Orderable Device Status Package Type Package Pins Package Eco Plan MSL Peak Temp Op Temp (°C) Device Marking Samples Qty Drawing (1) (2) (6) (3) (4/5)ACTIVE VSSOF CU NIPDAU Level-1-260C-UNLIM SBUI CAVC2T45TDCURQ1 DCU 8 Green (RoHS -40 to 125 3000 Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
- (6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Addendum-Page 1



Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

www.ti.com 17-Aug-2015

OTHER QUALIFIED VERSIONS OF SN74A	VC2T45-Q1:
-----------------------------------	------------

• Catalog: SN74AVC2T45

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

Addendum-Page 2

Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

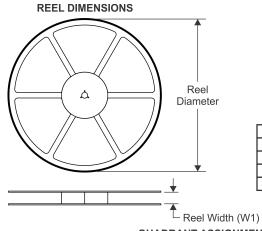
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

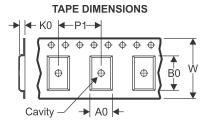


PACKAGE MATERIALS INFORMATION

www.ti.com 19-Aug-2015

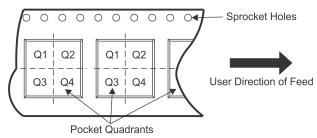
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CAVC2T45TDCURQ1	VSSOP	DCU	8	3000	180.0	8.4	2.25	3.35	1.05	4.0	8.0	Q3



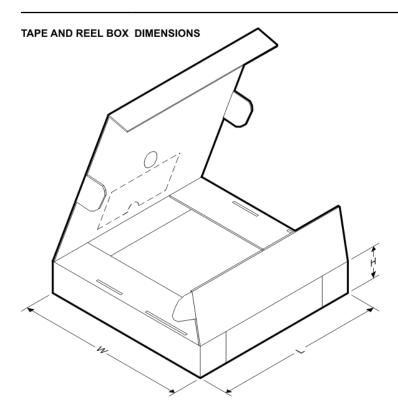
Distributor of Texas Instruments: Excellent Integrated System LimitedDatasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PACKAGE MATERIALS INFORMATION

www.ti.com 19-Aug-2015



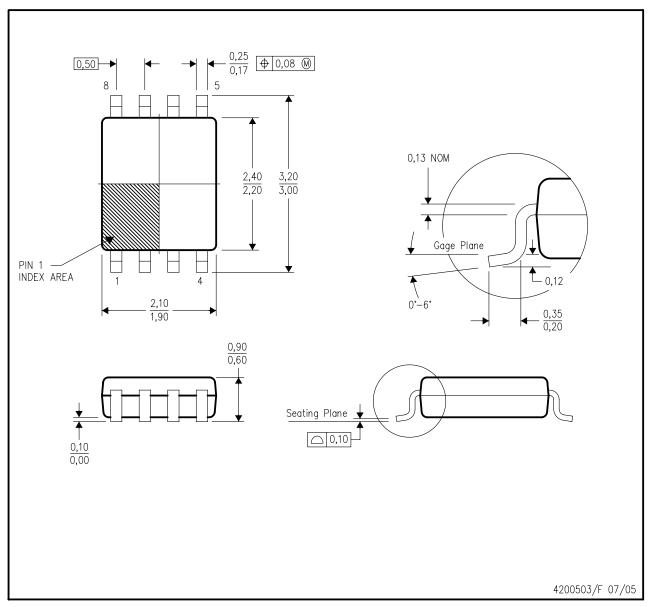
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CAVC2T45TDCURQ1	VSSOP	DCU	8	3000	202.0	201.0	28.0



MECHANICAL DATA

DCU (R-PDSO-G8) PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.

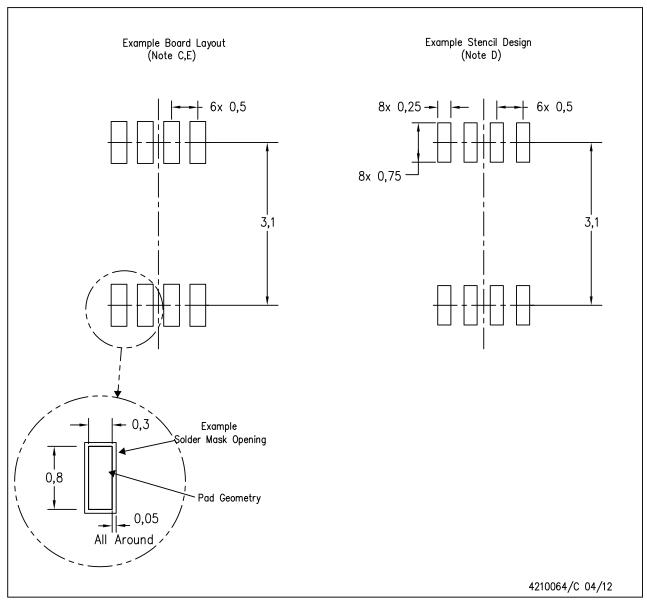




LAND PATTERN DATA

DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of CAVC2T45TDCURQ1 - IC BUS TXRX 3-ST DUAL US8

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical

Security Power Mgmt Space, Avionics and Defense www.ti.com/space-avionics-defense power.ti.com

www.ti.com/security

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

Products

Logic

OMAP Applications Processors TI E2E Community www.ti.com/omap e2e.ti.com

www.ti.com/wirelessconnectivity Wireless Connectivity

logic.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated